



Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from,Europe,America and south Asia,supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of “Quality Parts,Customers Priority,Honest Operation,and Considerate Service”,our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip,ALPS,ROHM,Xilinx,Pulse,ON,Everlight and Freescale. Main products comprise IC,Modules,Potentiometer,IC Socket,Relay,Connector.Our parts cover such applications as commercial,industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



## Contact us

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# Board Level Cooling – Extruded Collar 3250



## BOARD LEVEL COOLING – Extruded Collar 3250

Extruded Collar 3250 is a series of radial board level heat sinks designed to cool TO-5 devices. Representative image only.

## ORDERING INFORMATION

Part Number	Device Type
325705B00000G	TO-5
326005B00000G	TO-5
326005R00000G	TO-5



## HEAT SINK DETAILS

Property	Details
Material	Aluminum
Finish	Black Anodize
Finish: 326005R00000G	Red Anodize
Device Attachment Options	Slide On
Thermal Interface Material	-

Property	Details
Heat Sink Width (mm)	12.70
Heat Sink Length (mm)	12.70
Heat Sink Height (mm)	See "A" Dim below
Heat Sink Mounting Direction	Vertical

## MECHANICAL & PERFORMANCE

Drawing dimensions are shown in mm, (in)

Part Number	"A" Dim
325705B00000G	6.35
326005B00000G	9.52
326005R00000G	9.52

